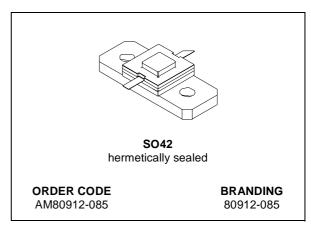


AM80912-085

RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

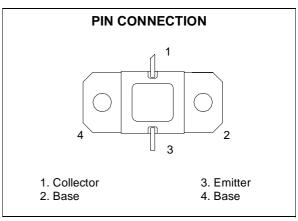
- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- 5:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P_{OUT} = 80 W MIN. WITH 7.27 dB GAIN



DESCRIPTION

The AM80912-085 is designed for specialized avionics applications including JTIDS, where power is provided under pulse formats utilizing short pulse widths and high burst or overall duty cycles.

The AM80912-085 is housed in a unique BIG-PACTM Hermetic Metal/Ceramic package with internal input/output impedance matching.



ABSOLUTE MAXIMUM RATINGS $(T_{CASE} = 25 \degree C)$

Symbol	Parameter	Value	Unit
P _{DISS}	Power Dissipation* (T _C ≤ 100 °C)	300	W
Ic	Device Current*	8.0	А
V _{cc}	Collector-Supply Voltage*	40	V
Tj	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	- 65 to +200	°C

THERMAL DATA

R _{th(j-c)}	Junction -Case Thermal Resistance*	0.75	°C/W
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^{*} Applies only to rated RF amplifier operation

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ELECTRICAL SPECIFICATION (T_{CASE} = 25 °C)

STATIC

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
BV _{CBO}	$I_C = 25mA$ $I_E = 0mA$	55			V
BV _{EBO}	I _C = 0mA I _E = 10mA	3.5			V
BV _{CER}	$I_C = 25\text{mA}$ $R_{BE} = 10\Omega$	55			V
ICES	V _{BE} = 0V V _{CE} = 35V			20	mA
h _{FE}	V _{CE} = 5V I _C = 3A	20		200	

DYNAMIC

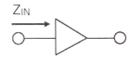
Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Pout	f = 960 - 1215MHz P _{IN} = 15 W V _{CC} = 35V	80			W
G _P	f = 960 - 1215MHz P _{IN} = 15 W V _{CC} = 35V	7.27			dB
ης	f = 960 - 1215MHz P _{IN} = 15 W V _{CC} = 35V	35			%

Note: Pulse format: $6.4~\mu S$ on $6.6\mu S$ off, repeat for 3.3 ms, then off for 4.5125 ms Duty Cycle: Burst 49.2%, overall 20.8%

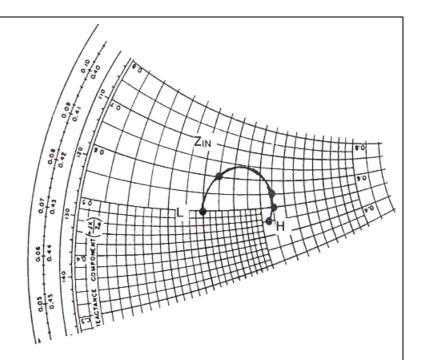
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IMPEDANCE DATA

TYPICAL INPUT IMPEDANCE

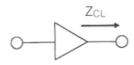


 P_{IN} = 15 W V_{CC} = 35 V Normalized to 20 ohms

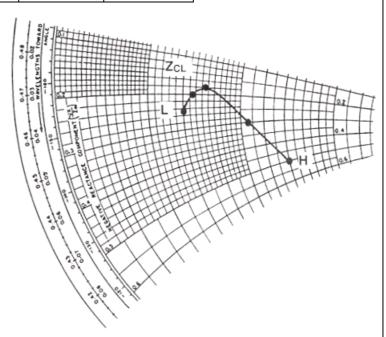


FREQ.	$Z_{IN}(\Omega)$	$Z_{CL}(\Omega)$
L = 960 MHz	3.0 + j 5.0	7.0 - j 5.0
• = 1025 MHz	3.5 + j 6.0	5.3 - j 3.0
M = 1090 MHz	5.5 + j 5.5	3.7 - j 1.8
• = 1150 MHz	5.5 + j 5.0	3.3 - j 2.0
H = 1215 MHz	5.3 + j 4.5	3.0 - j 2.5

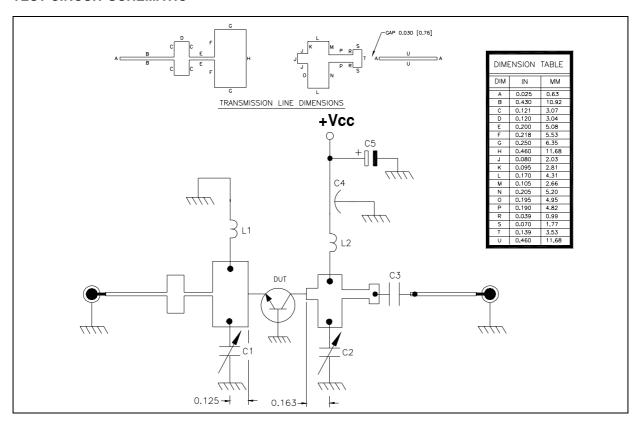
TYPICAL COLLECTOR LOAD IMPEDANCE



 P_{IN} = 15 W V_{CC} = 35 V Normalized to 20 ohms



TEST CIRCUIT SCHEMATIC



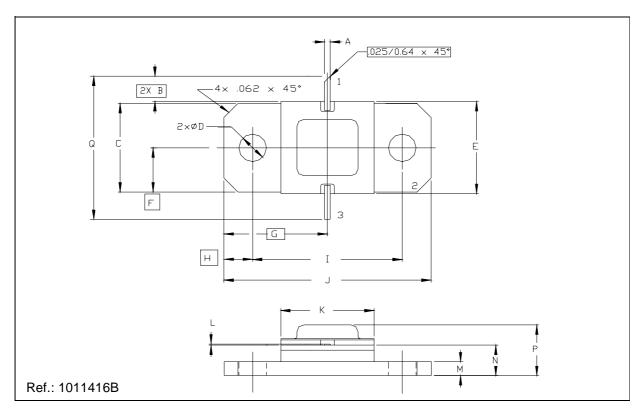
TEST CIRCUIT COMPONENT PART LIST

C1, C2	0.6 - 4.5 pF GIGA-TRIM VARIABLE CAPACITOR
C3	100 pF SURFACE MOUNT CERAMIC CHIP CAPACITOR
C4	1000 pF RESIN SEALED #8-32 THREADED FEEDTHRU CAPACITOR
C5	100 μF / 63 V ALUMINUM ELECTROLYTIC AXIAL LEAD CAPACITOR
L1, L2	INDUCTOR 4 TURNS #26 AWG, ID = 0.0625 [1.58] SOLID TINNED BUS BAR WIRE
PCB	0.025 inch thick Al_2O_3 , $\varepsilon r = 9.6$

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SO42 (.400 X .400 2/L HERM. W/FLG.) MECHANICAL DATA

DIM.		mm			Inch	
	MIN.	TYP.	MAX	MIN.	TYP.	MAX
Α	0.51		0.76	0.020		0.030
В		6.35			0.250	
С	9.55		10.06	0.376		0.396
D	2.79		3.30	0.110		0.130
E	10.03		10.34	0.395		0.407
F		4.90			0.193	
G		11.43			0.450	
Н		3.18			0.125	
I	16.26		16.76	0.640		0.660
J	22.61		23.11	0.890		0.910
K	10.03		10.54	0.395		0.415
L	0.10		0.18	0.004		0.006
М	1.32		1.83	0.052		0.072
N	2.84		3.35	0.112		0.132
Р			5.84			0.230
Q	22.35		23.37	0.880		0.920



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